

Title (en)

Substrat to contact a flexible flat cable

Title (de)

Substrat zur Kontaktierung mit einem Flachleiterelement

Title (fr)

Substrat pour contacter un câble flexible

Publication

**EP 1715548 B1 20071003 (DE)**

Application

**EP 05008688 A 20050420**

Priority

EP 05008688 A 20050420

Abstract (en)

[origin: EP1715548A1] The substrate has an opening (12) for insertion into a flat conductor unit. An electrical substrate contact (20) forms an electrical connection with an electrical flat conductor contact of a flat conductor unit. The contact (20) is introduced at an edge of the opening, such that the conductor contact coincides with the contact (20). The contact (20) is lowered in an area of the opening opposite to a surrounded substrate surface. An independent claim is also included for a method for electrical connection of a flat conductor unit to a substrate.

IPC 8 full level

**H01R 12/24** (2006.01); **H01R 4/02** (2006.01); **H01R 12/62** (2011.01)

CPC (source: EP)

**H01R 4/028** (2013.01); **H01R 12/62** (2013.01); **H01R 12/774** (2013.01); **H01R 13/6273** (2013.01)

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